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H8/300H Tiny Series

Conversion of an 8-Bit Binary Number to Two Digits of ASCII Code (COBYTE)

Introduction

Converts an 8-bit binary number to the corresponding two-digit ASCII code.

Target Device

H8/300H Tiny Series

Contents

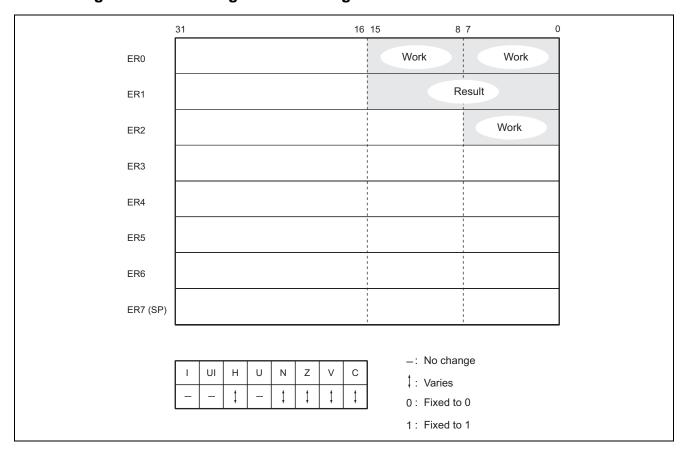
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1. Arguments

Content	:S	Storage Location	Data Length (Bytes)
Input	8-bit binary number	R0L	1
Output	2-digit ASCII code	R1	2

2. Changes to Internal Registers and Flags





3. Programming Specifications

Γ	Program memory (bytes)
Ī	38
	Data memory (bytes)
Ī	0
	Stack (bytes)
Ī	0
	Number of cycles
Ī	72
ſ	Re-entrant
Ī	Yes
	Relocatable
	Yes
Γ	Interrupts during execution
	Yes



4. Description

4.1 Description of Functions

- 1. The arguments are as follows.
 - R0L: Holds the 8-bit binary number for conversion to ASCII code as the input argument.
 - R1 : The result of conversion to two digits of ASCII code is set here; the respective digits correspond to the higher- and lower-order four bits of the 8-bit binary number.
- 2. The following figure illustrates the execution of the COBYTE subroutine. After the input argument has been set, the 8-bit binary number is converted to ASCII code and the result placed in R1.

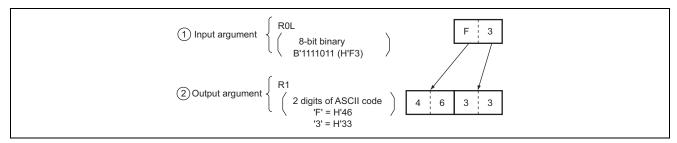


Figure 1 Example of COBYTE Execution

4.2 Usage Note

The 8-bit binary number in R0L is lost in the execution of COBYTE.

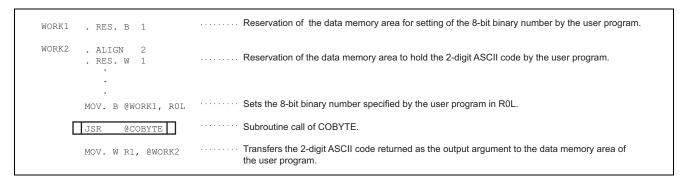
4.3 Description of Data Memory

No data memory is used by COBYTE.



4.4 Example of Usage

After setting the 8-bit binary number, call the COBYTE subroutine.



4.5 Principles of Operation

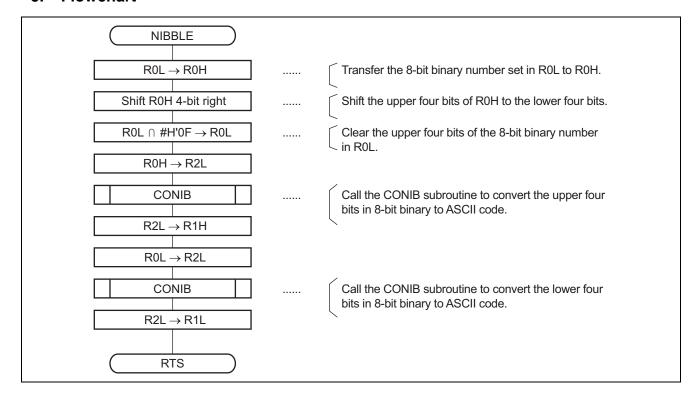
- 1. The 8-bit binary number set in R0L is divided into the higher- and lower-order 4-bit units.
- 2. The data in each set of four bits is tested by the comparison instruction (CMP.B). H'30 is added to a value in the range from H'00 to H'09 (the part enclosed by in the ASCII code table below); H'37 is added to a value from H'0A to H'0F (the part enclosed by in the table). The data is thus converted to ASCII code.

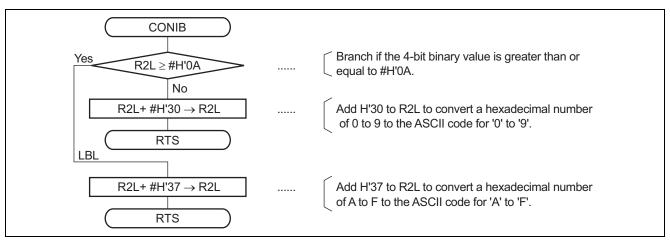
Table 4.1 ASCII Coding

	MSD	0	1	2	3		4	5	6	7
LSD		000	001	010	011		100	101	110	111
0	0000	NUL	DLE	SP	0		@	Р	`	р
1	0001	SOH	DC_1	!	1		Α	Q	а	q
2	0010	STX	DC_2	"	2		В	R	b	r
3	0011	ETX	DC_3	#	3		С	S	С	S
4	0100	EOT	DC_4	\$	4		D	Т	d	t
5	0101	ENG	NAK	%	5		E	U	е	u
6	0110	ACK	SYN	&	6		F	V	f	V
7	0111	BEL	ETB	•	7	-	G	W	g	W
8	1000	BS	CAN	(8		Н	Χ	h	х
9	1001	HT	EM)	9		I	Υ	i	у
Α	1010	LF	SUB	*	:		J	Z	j	Z
В	1011	VT	ESC	+	,		K	[k	{
С	1100	FF	FS	,	<		L	\	I	
D	1101	CR	GS	-	=		M]	m	}
E	1110	SO	RS		>		N	\uparrow	n	~
F	1111	SI	VS	/	?		0	\leftarrow	0	DEL



5. Flowchart







6. Program Listing

				_					
1				1	•	******	******	*********	* * * *
2				2	; *	272247	GUANGE O DEE	DIMARK	*
3				3	; *		CHANGE 8 BIT		*
4				4	; *		TO 2 BYTE AS	CII CODE (COBYTE)	*
5				5	;*			*******	
6				6	•	******	*****	****	* * * *
7				7	; *				*
8				8	; *	ENTRY :	RUL	(8 BIT BINARY)	*
9					; *			(0	*
10					; *	RETURN :	RI	(2 BYTE ASCII CODE)	*
11					;*			*******	
12					•				^ ^ ^ ^
13				13	;	CDII	200177		
14	0000			14		.CPU	300HN	CODE ALTON O	
15	0000			15		.SECTION		,CODE,ALIGN=2	
16				16		.EXPORT	COBYTE		
17		0000000			;	F011	4	· Porton and state	
18	0000	00000000		18	COBYTE	MOV.B	\$ ROL,ROH	;Entry point	
19	0000	0080		19		MOV.B	RUL, RUH		
20 21	0002	1100		20	;	CIII D	R0H		
22	0002	1100		21 22		SHLR	ROH		
23	0004			23		SHLR	ROH		
24	0008			24		SHLR		;Shift high 4 bits to low	4 bita (P04)
25	0000	1100		25	;	SHLK	KOH	73HITE HIGH 4 DIES CO TOW	4 DICS (ROH)
26	0007	E80F		26	,	AND.B	#שיחה פחז	;Select lower 4 bits (ROL	١
27	OUUA	EOUF		27	;	AND.B	#H OF, KOL	/Select lower 4 Dits (ROL	,
28	ດດດຕ	0C0A		28	,	MOV.B	ROH,R2L		
29		550A		29		BSR		;Branch subroutine CONIB	
30		OCA1		30		MOV.B		;Set 1st ASCII code in R1	4
31	0010	OCIII		31	;	110 V.D	RZE/RIII	, bee 180 Abell code in kin	·•
32	0012	0C8A		32	,	MOV.B	ROL,R2L		
33		5504		33		BSR		;Branch subroutine CONIB	
34		OCA9		34		MOV.B		;Set 2nd ASCII code in R11	Γ.
35					;		,		
36	0018	5470		36		RTS			
37				37	;				
38	001A			38	CONIB			;Change R2L to ASCII code	
39	001A	AA0A		39		CMP.B	#H'0A,R2L	5	
40		4404		40		BCC	LBL	;Branch if R2L will be ASO	CII "A"-"F"
41	001E	8A30		41		ADD.B	#H'30,R2L	;Reshape R2L to ASCII "0"	-"9"
42	0020	5470		42		RTS			
43				43	;				
44	0022	8A37		44	LBL	ADD.B	#H'37,R2L		
45		5470		45		RTS			
46				46	;				
47				47		.END			
****	TOTAL	ERRORS	0						
****	TOTAL	WARNINGS	0						



Revision Record

		Description				
Rev.	Date	Page	Summary			
2.00	Feb.28.06	_	Format has been changed from Hitachi version to Renesas version.			



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